

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- High Temperature Soldering: 260°C/10 Second at Terminal
- Lead Free Finish/RoHS Compliant (Note 1)

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 ©3
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: SMA 0.064 grams (Approximate)
 SMB 0.093 grams (Approximate)





Top View

Bottom View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	B220/A	B230/A	B240/A	B250/A	B260/A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	35	42	V
Average Rectified Output Current @ T _T = 100°C	lo			2.0			Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}			50			Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal	$R_{ hetaJT}$	20	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 2)	$R_{ hetaJA}$	25	°C/W
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-65 to +150	°C

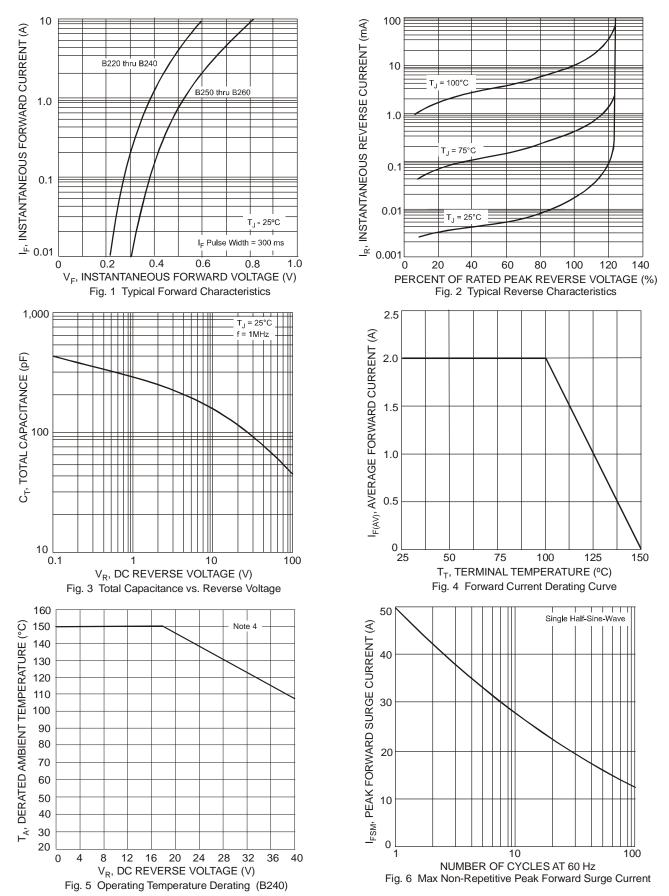
Electrical Characteristics @TA = 25°C unless otherwise specified

Charac	teristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	B220/A, B230/A, B240/A B250/A, B260/A	VF	-	-	0.50 0.70	٧	I _F = 2.0A, T _A = 25°C
Leakage Current (Note 3)		I _R	1 1	i i	0.5 20	mA	 @ Rated V_R, T_A = 25°C @ Rated V_R, T_A = 100°C
Total Capacitance		C_{T}	-	-	200	pF	$V_R = 4V$, $f = 1MHz$

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Thermal Resistance: Junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pad as heat sink.
- 3. Short duration pulse test used to minimize self-heating effect.





^{4.} Device mounted on FR-4 PC board with minimum recommended pad layout pattern as per http://www.diodes.com/datasheets/ap02001.pdf.



Ordering Information (Note 5)

Part Number	Case	Packaging
B2xxA-13-F	SMA	5000/Tape & Reel
B2xx-13-F	SMB	3000/Tape & Reel

^{*} x = Device type, e.g. B260A-13-F (SMA package); B240-13-F (SMB package).

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



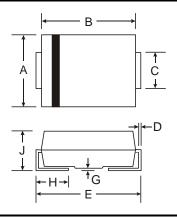
B2X0A = Product type marking code, ex: B220A (SMA package) B2X0 = Product type marking code, ex: B230 (SMB package)

TWW = Date code marking

Y = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52

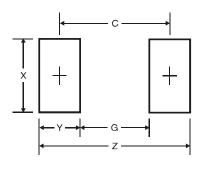
Package Outline Dimensions



SMA			
Dim	Min	Max	
Α	2.29	2.92	
В	4.00	4.60	
С	1.27	1.63	
D	0.15	0.31	
Е	4.80	5.59	
G	0.05	0.20	
Н	0.76	1.52	
J	2.01	2.30	
All Dimensions in mm			

SMB			
Dim	Min	Max	
Α	3.30	3.94	
В	4.06	4.57	
C	1.96	2.21	
D	0.15	0.31	
Е	5.00	5.59	
G	0.05	0.20	
Ι	0.76	1.52	
J	2.00	2.62	
All Dimensions in mm			

Suggested Pad Layout



SMA Dimensions	Value (in mm)
Z	6.5
G	1.5
Х	1.7
Υ	2.5
С	4.0

SMB	Value (in mm	
Dimensions	value (III IIIII)	
Z	6.7	
G	1.8	
Х	2.3	
Y	2.5	
С	4.3	

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